

<b>Notice of References Cited</b>		Application/Control No. 09/444,675	Applicant(s)/Patent Under Reexamination KOIZUMI ET AL.	
		Examiner Heather R. Jones	Art Unit 2615	Page 1 of 1

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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

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